

MEAS | MEAS MCD

TE Internal #: GA10K3MCD1

TE Internal Description: MCD PROBE, 10K OHMS,

Thermistor Probe — Micro BetaCHIP (MCD)

View on TE.com >



Sensors > Temperature Sensors > NTC Thermistors Sensors & Probes > NTC Thermistors > Thermistor Probe — Micro BetaCHIP (MCD)



Discrete NTC Sensor Type: **Epoxy Coated NTC Thermistor**

Wire Connection: Open End

Discrete NTC Wire Length: 152 mm

Resistance (at 25°C): $10 \text{ k}\Omega$ Tolerance Resistance: $\pm .88 \%$

All Thermistor Probe — Micro BetaCHIP (MCD) (3)

Features

Product Type Features

Troddet Type reatures	
Discrete NTC Sensor Type	Epoxy Coated NTC Thermistor
Tolerance β-Value	±0.5 %
Electrical Characteristics	
β -Value(25/85)	3976 K
Body Features	
Wire Connection	Open End
Dimensions	
Discrete NTC Wire Length	152 mm
Usage Conditions	
Resistance (at 25°C)	10 kΩ
Tolerance Resistance	± .88 %
Discrete NTC Ambient Temperature Range	-40 – 125 °C
Temperature Accuracy	± .2 from 0 – 70 °C
Maximum Temperature	125 °C
Operation/Application	

38 AWG Solid Nickel Bifilar, Polyester

Wire/Cladding Connection



Packaging Features

Discrete NTC Package	Micro Epoxy Discrete
----------------------	----------------------

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Yet Reviewed for halogen content
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

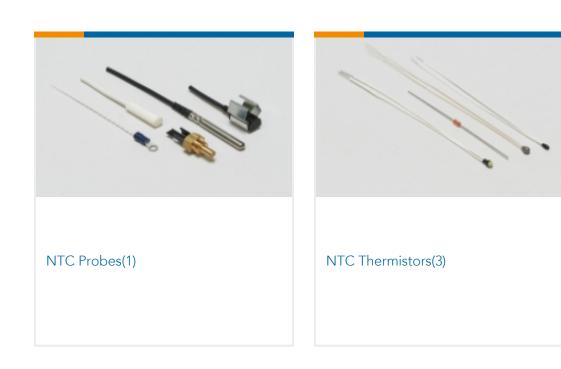






Also in the Series | MEAS MCD





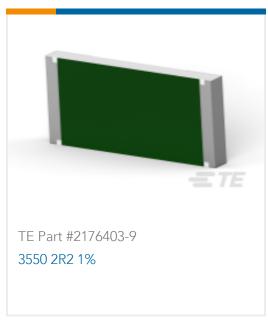
Customers Also Bought





















Documents

Datasheets & Catalog Pages

GA10K3MCD1 MICRO BetaCHIP (MCD) THERMISTOR PROBES

English

MCD_10K3MCD1

English